

10-08-2002

FORM PTO-1595

U.S. DEPARTMENT OF COMMERCE



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To the Honorable Commissioner of Patents, U.S. Department of Commerce, Washington, D.C. 20540. Please record the attached original documents or copy thereof.



Name of conveying party(ies):
Yee Loy LAM

Name and Address of receiving party(ies):

NANYANG TECHNOLOGICAL UNIVERSITY
School of Electrical & Electronic Engineering
Nanyang Avenue, 639798 Singapore

10-3-02

3. Nature of conveyance:
 Assignment _____ Merger
_____ Security Agreement _____ Change of Name
_____ Other: _____
Execution Date(s): August 16, 2002

4. Application number(s) or patent number(s):
 This document is being filed together with a new application:
(a) The execution date(s) of the application is/are:
(b) The title is:
OR
 This document is being filed after filing of the application:
(a) Patent Application No(s). 10/207,395, filed July 30, 2002; or
(b) Patent No(s). , issued .

5. Name and address of party to whom correspondence concerning document should be mailed:
STAAS & HALSEY LLP Our Docket: 469.1098
Attention: David M. Pitcher
700 Eleventh Street, N.W., Suite 500
Washington, D.C. 20001

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)..... (\$ 40.00 per Assignment)
 Enclosed
 Authorized to be charged to deposit account.

8. Deposit Account No.: 19-3935 (Any underpayment is authorized to be charged to this Deposit Account)
(Attach duplicate copy of this page if paying by deposit account)

9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David M. Pitcher, Reg. No. 25,908
Name of Person Signing

David M. Pitcher
Signature

October 3, 2002
Date

10/07/2002 0111E91 00000164 10207395

Total number of pages including cover sheet: 2

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Name(s) of Inventors

(1) Yee Loy LAM

In consideration of the sum of one dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned agree(s) to assign, and hereby do(es) assign, transfer and set over to

Name of Assignee **NANYANG TECHNOLOGICAL UNIVERSITY**

Address of Assignee **School of Electrical & Electronic Engineering
Nanyang Avenue, 639798 Singapore**

(hereinafter designated as the Assignee) the entire right, title and interest for the United States, its territories, dependencies and possessions, in the invention, and all applications for patent and any Letters Patent which may be granted therefor, known as

Title **HIGH DENSITY FIBRE COUPLING**

for which the undersigned has (have) executed an application for patent in the United States of America

Date of Signing

of Application

on

Alternative Identification

for filed applications

U.S. Application Serial Number 10/207,395
filed July 30, 2002

- 1) The undersigned agree(s) to execute all papers necessary in connection with the application and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary.
- 2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.
- 3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.
- 4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.
- 5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has/she has (they have) full right to convey the entire interest herein assigned, and that he has/she has (they have) not executed, and will not execute, any agreements in conflict herewith.
- 6) The undersigned hereby grant(s) to the attorney(s) identified in the Declaration/Power of Attorney for this patent application, the power to insert on this assignment any further identification which may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 16 Aug 2002 Signature of Inventor (1) *Yee Loy*

Date 16 Aug 2002 Witness Chan Yuen Chuen *[Signature]*

Date 16 Aug 2002 Witness NG GEOR ING *[Signature]*

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